





data sheet

largest memory, smallest package available

The HP workstation j6700 delivers industry leading performance, unparalleled memory and compute density. It will ensure that you complete your designs and simulations faster than any other UNIX two way workstation. Whether used as a deskside configuration optimized for your office environment or a racked solution, the hp j6700's performance and reliability will satisfy the most demanding user.

When you need ultimate performance for today's toughest designs and simulations with the capacity to handle tomorrow's even bigger workloads, look to the HP workstation j6700. With HP and the HP workstation j6700, you have new ways to invent the future.

hp workstation i6700	feature	benefit	advantage
performance	2 PA-8700 RISC processors running at 750MHz	puts more compute and visualization power behind EDA and CAE applications; provides higher application performance at a lower price	holds the fastest microprocessor on the market
	16GB synchronous DRAM capacity	supports analysis of larger models	delivers higher application performance with less disk access; largest memory available
	2.25MB on-chip cache	enhances system performance with greater application speed and throughput; lowers cost	minimizes system latency
	four-way set associative cache	requires less disk-to-cache access for instructions and data, providing higher performance	decreases the miss rate of direct mapped cache
	64x64 operating system and microprocessor	improves large processing performance, such as full-chip simulation, logic synthesis and design rule checking	furnishes large address spaces
	1.9GB/s I/O peak performance	delivers excellent file server performance	provides fastest data transfer to I/O
integration	efficient rack mountable design	saves space, particularly when used in your compute room; up to 20 systems per 2m rack	flexible configurations increase system ver- satility
graphics	hp <i>fxe</i> graphics	enables universal access to all types of data across diverse, cross-functional teams	provides full-featured, 3D capability across all HP workstation platforms
	hp $fx^{10}pro$ graphics	greater user productivity and performance in mechanical applications	delivers the world's fastest 3D graphics performance for mechanical design and analysis work
investment protection	binary compatibility with future PA-RISC and Intel® Itanium™ processors	protects your investment in applications, data and systems	ensures smooth transition to HP's next-generation, high performance systems

hp workstation j6700 technical specifications

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central processor type clock frequency	PA-8700 750MHz
number of processors	2
primary cache (on chip) total cache instruction data	2.25MB 0.75MB 1.50MB
performance HP workstation performance results car http://www.hp.com/workstations/pro	
main memory bus bandwidth RAM type capacity memory slots	1.9GB/sec 120MHz SDRAM 1GB-16GB 16
PCI slots (3 total) PCI 4X (full size)	3 slots 4x slots 64-bit 3.3 volt 66MHz 20 watts per slot
internal storage devices Ultra 2 SCSI LVD	80 pin SCA connector 2 drives maximum (hot pluggable)
	18GB (10K RPM) 36GB (10K RPM) 36GB (15K RPM) 73GB (10K RPM)
removable media CD-ROM/CD-RW* interface	1 internal
*available on hp-ux 11.0 and higher σ	only
external storage Ultra2 SCSI LVD NSE SCSI	1 shared port – 13 devices 1 shared port – 7 devices
networking interface integrated LAN data rate	10/100 Base-Tx 10/100 Mbits/sec
other I/O USB Series A serial interface	2 ports (keyboard and mouse only) 2 ports
audio type inputs outputs	integrated, CD-quality stereo stereo line-in, MIC-in stereo line-out, internal speaker with frequency range of 25-20,000Hz, internal CD-ROM audio, headphone
monitor 18.1" (18.1" viewable) 19" (18" viewable) 21" (19.8" viewable) 24" (22.5" viewable)`	1280x1024 res LCD flat panel display 1600x1200 res. Flat FD Trinitron® CRT display 1600x1200 res flat FD Trinitron CRT display 1920x1200 res flat FD Triniton CRT display

operating systems su				
hp-ux 11i TCOE (Technical	Computing	Operating	En

hp-ux 11i MTOE (Minimal Technical Operating Environment) hp-ux 11.0

environmental specifications			
altitude .			
operating	0-3000m (0-10,000ft)		
non-operating	0-4500m (0-15,000ft)		
temperature			
operating	0 - +35 degrees C		
non-operating	-40 - +70 degrees C		
humidity			
operating	15-80% (non-condensing)		
vibration			
operating random	0.21 G rms, 5-500Hz		
swept sine survival	0.5 G peak, 5-500Hz		
random survival	2.09 G rms, 5-500Hz		
safety	UL1950, CUL to CSA C22.2#950, and TUV GS Mark to		
	EN60950/IEC950		
	EN00930/ IEC930		
emissions	FCC and CISPR Class B and VCCI		
Class B	Tee and clot k class b and veel		
Class B			
physical dimensions			
, height	49.5cm (19.5 inches)		
width	13.7cm (5.4 inches)		
depth	65.5cm (25.8 inches)		
physical dimensions with rack kit			
height	2 EIA units		
width	48.3cm (19.0 inches)		
depth	62.2cm (24.5 inches)		
rack orientation	horizontal		

net weight

6 amps RMS max
@ 100-120V
3 amps RMS max
@ 22 ['] 0-240V
50-60Hz
600watts*

*maximum power-configuration will vary

hp graphics	hp fxe	hp fx ¹⁰ pro	
graphics cards	3 max	2 max	
max resolutions*	1600x1200	1600x1200	
image planes/overlay	24/24DB**	24/24DB**	
planes	8 overlay	8 overlay	
z-buffer	24-bit HW	24-bit HW	
stencil planes	4-bit HW	4-bit HW	
Aapha planes	SW	8/8DB HW	
texture memory	Std. 9.5MB	Std. 110MB***	
color maps	0.0 / 1012	0.0.	
image planes	2 image	2 image	
overlay planes	2 overlay	2 overlay	
overlay planes	2 Overlay	2 Overlay	

with full feature set and 75Mz refresh

The hp workstation j6700 - power to invent in real time

For the latest information about HP workstations: http://www.hp.com/workstations

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^{**} DB=double buffered

^{***} at 1280×1024 resolution